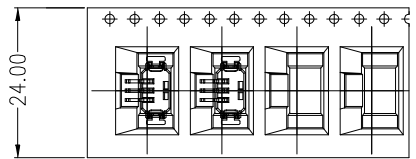


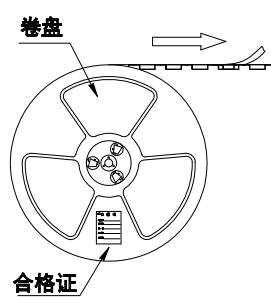
REVISION DATA				
REV	ECN No.	DESCRIPTION	NAME	DATE
A0		NEW DRAWING	D.Y.Y	2020-05-18

产品引出方向

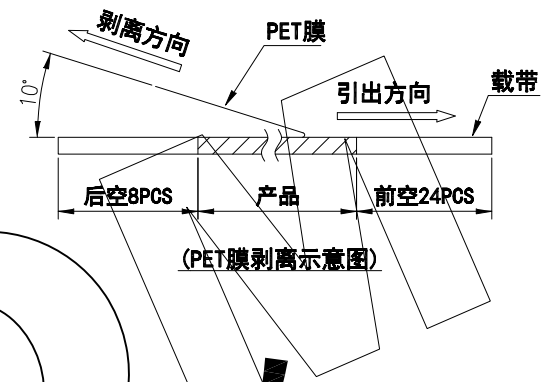


平面视图

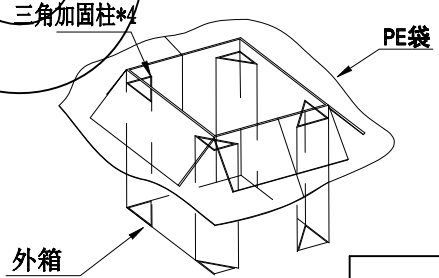
注:正对卷带, 上方为圆孔, 下方无孔为正面



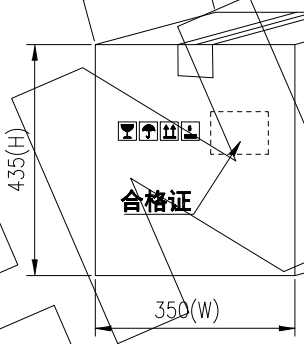
BSTXXX



装**盘(列表一)



350(L) 纸箱 (CARTON): 350*350*4



Reel/PCS	INNER BOX/PCS	INNER BOX/BOX	BOX/PCS
600	600	15	9000

Noted:卷带前空24PCS, 后空8PCS

包装说明:

- 步骤1: 将检验好的成品Dip朝下放入REEL卷带内,每卷装600PCS, 每卷需贴上合格标签.
- 步骤2: 外箱内先套一个大PE袋, 然后将装好产品的卷盘放进外箱中
- 步骤3: 封箱贴好胶纸.
- 步骤4: 在外箱上侧面右上角贴上相关标签.
- 步骤6: 打包扎带

注意: 如客户有特殊要求, 依客户要求包装.

ENKCOM® 东莞市恩康电子科技有限公司
 www.enkcom.com
 TEL:+86(0)769 8904 9672
 FAX:+86(0)769 8904 9671
 E-MAIL:sales@enkcom.tw
DONGGUAN ENKANG ELECTRONICS TECHNOLOGY CO.,LTD

TOLERANCE	DATE :	2020-05-18	TITLE:				
ANGLE ±5°	DRAWN :	D.Y.Y	Wafer PH1.5 H6.9 4P 卷装包装规范				
X.XXX ±0.15	CHECKED :		PART NO: WFHR11004XXXXLR001				
X.XX ±0.25	APPROVED :						
X.X ±0.40	PROJECTON		REV: A0	UNIT: mm	SCALE: 1:1	SIZE: A4	PAGE 1/1
X. ±0.50							